

VDS	RDS(on)	ID@25℃
1200V	140mΩ	17A

Applications:

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- EV Charging
- Motor Drives

Features:

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness

Benefits:

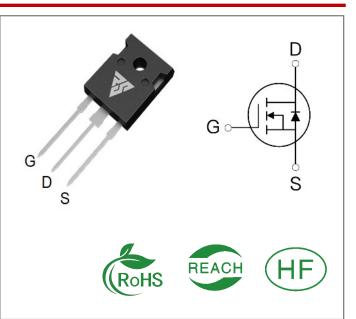
- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Ordering Information

Part Number	Package	Marking	Packing	Qty.
RSM120160W	TO-247-3	RSM120160W	Tube	30 PCS

Maximum Ratings (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VDSmax	Drain - Source Voltage	1200	V	VGS=0V,ID =100µA	
VGSmax	Gate - Source Voltage	-8/+22	V	Absolute maximum values	
VGSop	Gate - Source Voltage	-4/+18	V	Recommended operational values	
ID	Continuous Drain	17	А	VGS=18V, TC =25℃	
	Current	12		VGS=18V, TC =100℃	
ID(pulse)	Pulsed Drain Current	39	А	Pulse width tp limited by TJmax	
PD	Power Dissipation	83	W	TC =25℃, TJ =175℃	
TL	Solder Temperature	260	°C		
.	Operating Junction and	-55 to	°C		
TJ, Tstg	StorageTemperature	+ 175	U		





Electrical Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
V(BR)D SS	Drain-Source Breakdown Voltage	1200			V	VGS=0V,ID =100µA	
	Gate Threshold	1.9	2.6	4.0	V	VGS= VDS, IDS=2.5mA, TC =25℃	
VGS(th)	Voltage		1.8		V	VGS= VDS, IDS=2.5mA, TC =175℃	
IDSS	Zero Gate Voltage Drain Current		1	100	μA	VDS= 1200V, VGS=0V	
IGSS	Gate-Source Leakage Current		10	250	nA	VGS=22V, VDS= 0V	
D	Drain-Source on-state		140	185	mΩ	VGS=18V, ID =8.5A, TC =25℃	
RDS(on)	Resistance		248	300	mΩ	VGS=18V, ID =8.5A, TC =175℃	
Ciss	Input Capacitance		612				
Coss	Output Capacitance		34.5		pF	VGS=0V, VDS=1000 V,	
Crss	Reverse Transfer Capacitance		8.77			f=1MHz , V ^{AC} =25 mV	
EON	Turn-On Switching Energy		305		uJ	VDS =800V, VGS=-4/18V,ID = 8.5A,	
EOFF	Turn-Off Energy		48			$RG(ext) = 2.5\Omega, L = 100\mu H$	
td(on)	Turn-On Delay Time		7				
tr	Rise Time		30		ns	VDS =800V, VGS =-4/18 V ID = 8.5A, RG(ext) =2. 5 Ω ,	
td(off)	Turn-Off Delay Time		16		115	$RL = 20\Omega$	
tf	Fall Time		22				
RG(int)	Internal Gate Resistance		5		Ω	f=1 MHz, VAC=25mV	
Qgs	Gate to Source Charge		7.8				
Qgd	Gate to Drain Charge		12.1		nC	VDS=800V, VGS=-4/18V ID =8.5A	
Qg	Total Gate Charge		42.5				



Reverse Diode Characteristics (TJ= 25° C unless otherwise specified)

Symbol	Parameter	Тур.	Max	Unit	Test Conditions	Note
	Diada Famurand Malta an	4.2		V	VGS=-4V, ISD =4.2A, TJ = 25℃	
VSD	Diode Forward Voltage	3.9		V	VGS=-4V, ISD=4.2 A, TJ= 175℃	
IS	Continuous Diode Forward Current		17	А	TC= 25℃	
trr	Reverse Recovery time	20		ns		
Qrr	Reverse Recovery Charge	29		nC	ISD= 8.5 A, VR = 800V	
Irrm	Peak Reverse Recovery Current	2.5		А		

Thermal Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
RθJC	Thermal Resistance from Junction to Case	1.75	°C /\A/		
RθJA	Thermal Resistance From Junction to Ambient	40	°℃/W		



Typical Feature Curve

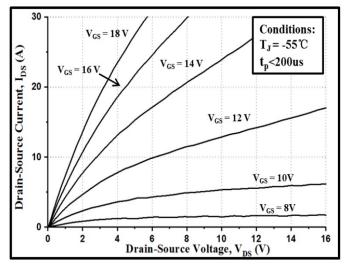
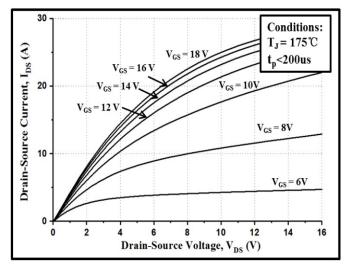
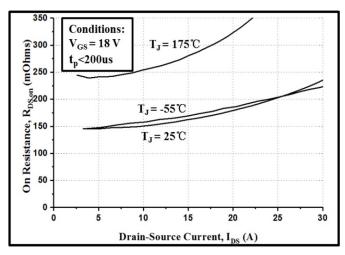
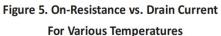


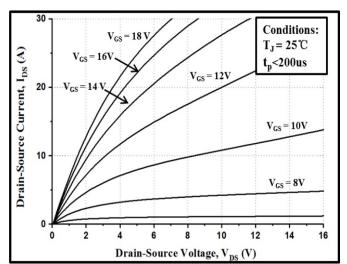
Figure 1. Output Characteristics T₁ = -55 °C













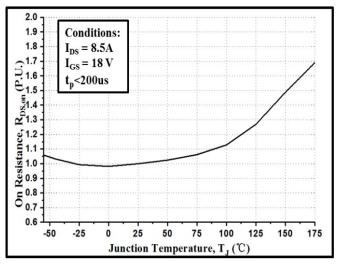
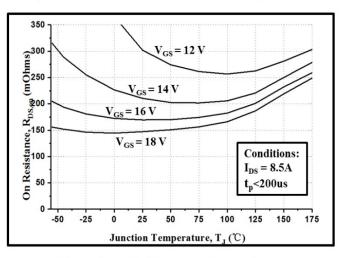
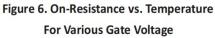


Figure 4. Normalized On-Resistance vs. Temperature







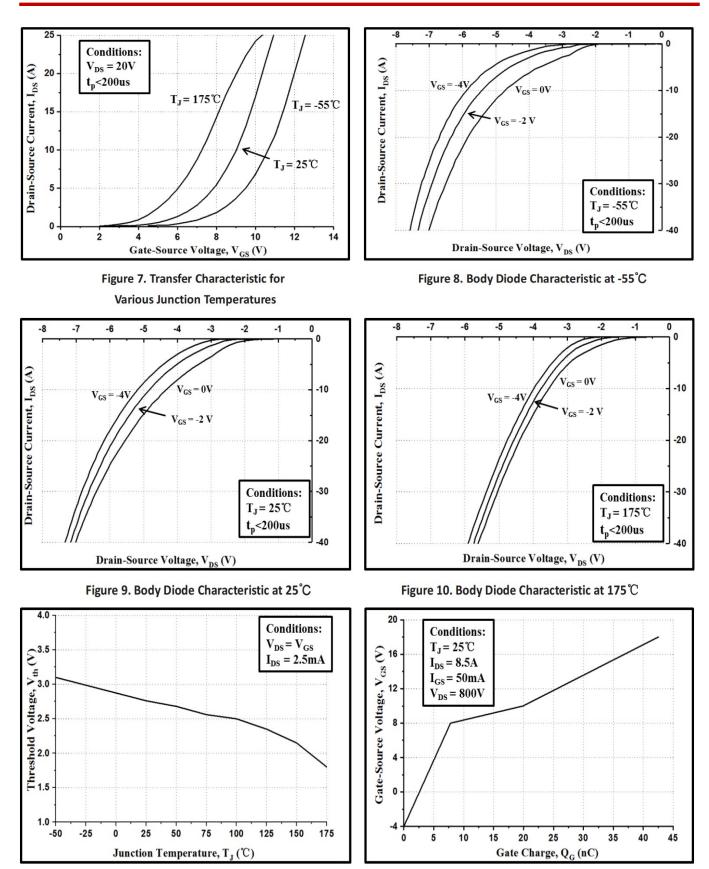
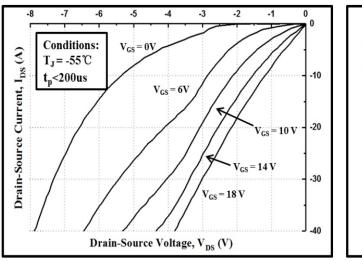


Figure 11. Threshold Voltage vs. Temperature









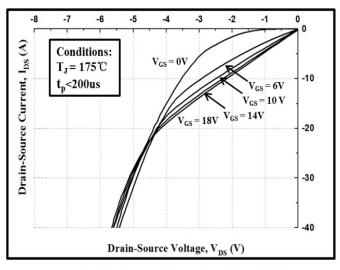
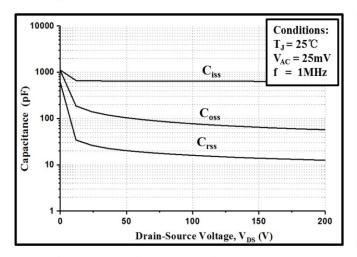
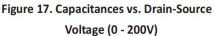
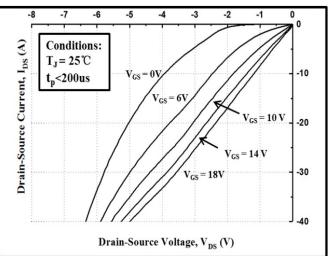


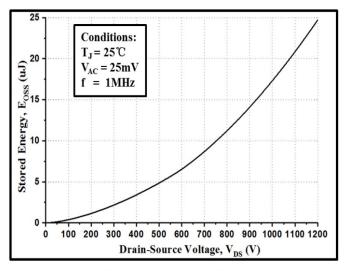
Figure 15. 3rd Quadrant Characteristic at 175 °C



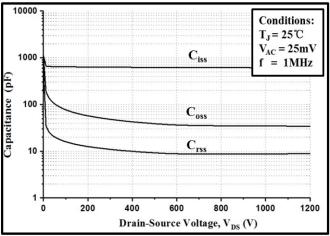


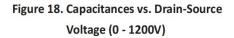




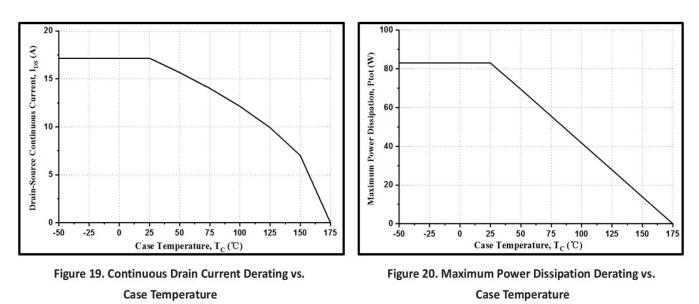












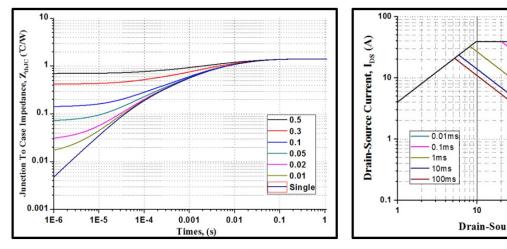


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



Test Circuit Schematic

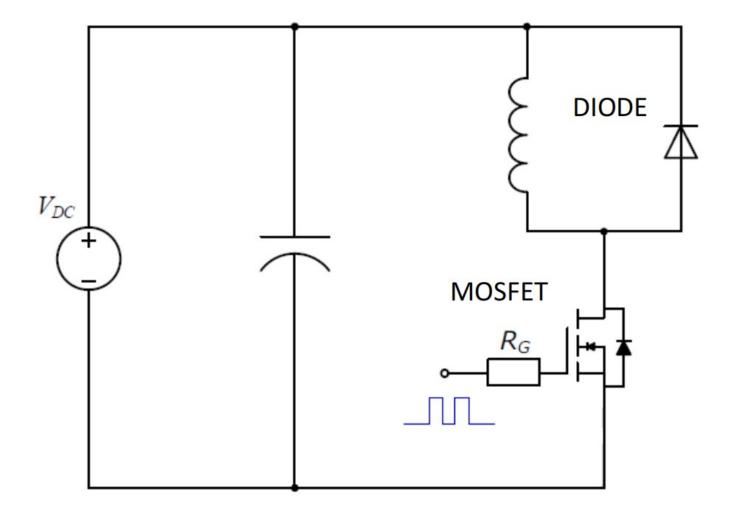
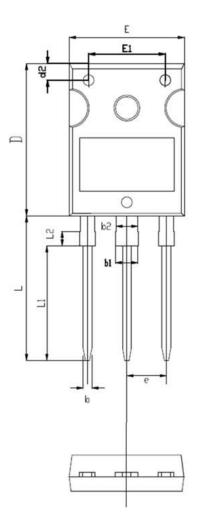


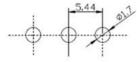
Figure 23. Clamped Inductive Switching Waveform Test Circuit



Package outline drawing(TO-247-3 Unit: mm)



RECOMMENDED LAND PATTERN



UNIT: mm

A1	62-			
	А	MIN 4.80	NOM 5.00	MAX 5.20
	A1	2.80	3.00	3.20
	A2	2.26	2.41	2.56
	b	1.10	1.20	1.30
	b1	2.90	-	3.20
	b2	2.90	3.00	3.10
	b3	1.90	2.00	2.10
	b4	2.00	-	2.20
	C	0.50	0.60	0.70
	D D1	20.80	21.00 8.23	21.20
	D1 D2		8.32	
	D2 D3		1.17	
	d1	6.00	6.15	6.30
	d2	2.20	2.30	2.40
	E	15.60	15.80	16.00
	E1		10.50	
	E2		14.02	
	E3	5.34	13.50 5.44	5.54
	e L	5.34 19.72	5.44 19.92	20.12
	L1	10114	15.79	20.12
	L2		1.98	
	øl	7.10	7.19	7.30
	ø2	3.50	3.60	3.70



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